

Item no.: APUPAD - Thermal conductive pad





Product Description

PC Engines APUPAD - Thermal conductive pad The APUPAD is a thermal conductive pad for APU system boards. This part is included with APU system boards, replacements are provided on request.

Size: 15 x 15 x 0.5 mm
Thermal conductance: 6 W/mK

BSpecifications

Scan this QR code to view the product All details, up-to-date prices and availability

